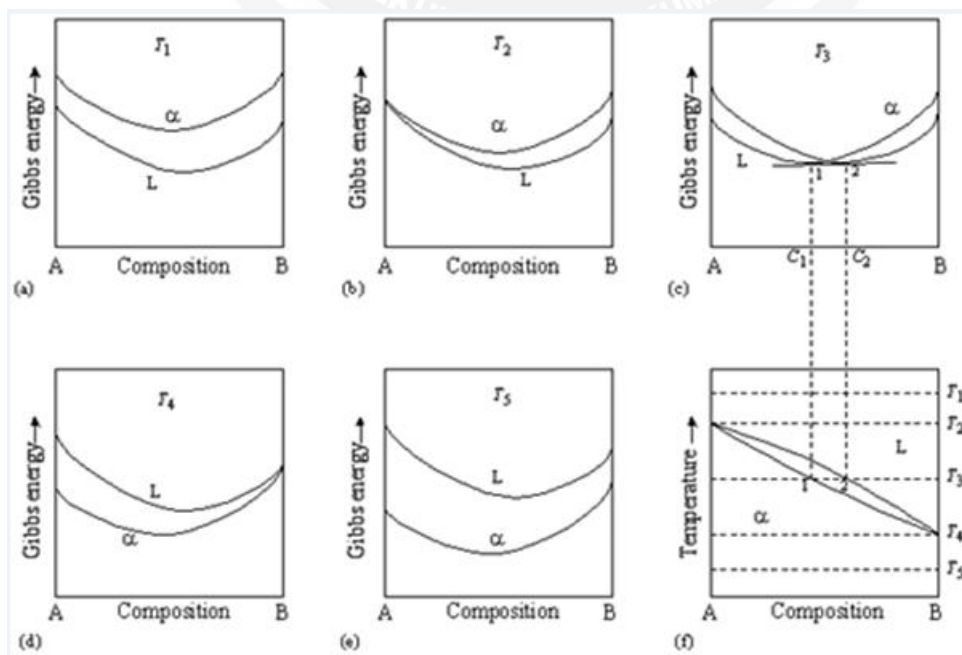


## Free energy composition curves for binary systems

- ❖ A binary phase diagram is a map which indicates the equilibrium phases present at a given temperature and composition. Free energy is a measure of a system's internal energy which gives the entropy of the system. For any phase, the Gibbs free energy is a function of pressure, temperature, and composition.

### Step (I)

- ❖ Let's construct a binary phase diagram for the simplest case: A and B components are mutually soluble in any amounts in both solid (**isomorphous system**) and liquid phases, and form ideal solutions.
- ❖ We have 2 phases – liquid and solid.
- ❖ Let's consider Gibbs free energy curves for the two phases at different Temperature.
- ❖  $T_1$  is above the equilibrium melting temperatures of both pure components:  $T_1 > T_m(A) > T_m(B)$ . At temperature  $T_1$ , the liquid phase will be the stable phase for any composition, because of its low Gibbs free energy.



Free energy composition curves for binary systems

**Step (II)**

At temperature  $T_2$ , component A begins to melt. The liquid and solid phases are equally stable only at a composition of pure A i.e.,  $G_{liquid}^A = G_{solid}^A$

**Step (III)**

- ❖ At temperature  $T_3$ , the Gibbs free energy curves for the liquid and solid phases will cross each other.

**Step (IV)**

- ❖ At temperature  $T_4$ , the component begins to melt as it is the melting temperature of component B.

**Step (V)**

- ❖ At lower temperature Gibbs free energy of the solid phase is lower than the G of the liquid phase ( $G_s < G_L$ ), so that solid phase is more stable at  $T_5$ .

**Construction of Phase diagram of components with complete solubility**

- The isomorphous phase diagrams having completely soluble components can be constructed from Gibb's free energy curves.
- At temperature  $T_3$ , the Gibbs free energy curves for the liquid and solid phases will cross each other.
- The common tangent construction can be used to show the compositions two phases in equilibrium.
- The two-phase field consists of a mixture of a mixture of liquid and solid phases.
- The compositions of the two phases in equilibrium at temperature  $T_3$  are given as  $C_1$  and  $C_2$ .
- The point of tangency, 1 and 2, are called solidus and liquidus respectively.
- The horizontal isothermal line meeting points 1 and 2 at temperature  $T_3$ , is called tie-line.

- Similar tie-lines meet the coexisting phases throughout all two phase field in binary system.

### Microstructural Change during Cooling

- In any binary system (isomorphous, eutectic, and peritectic), the microstructure of the elements change during cooling.
- Let us consider the copper–nickel system. In this system temperature is plotted along the Y-axis, and the X-axis represents the composition of the alloy.
- For example, specifically an alloy of composition 35 wt% Ni–65 wt% Cu as it is cooled from 1300°C.
- At 1300°C, point *a*, the alloy is completely liquid (of composition 35 wt% Ni–65 wt% Cu) and has the microstructure represented by the circle inset in the figure.
- As cooling begins, no microstructural or compositional changes will be realized until it reaches the liquidus line (point *b*, ~1260°C). At this point the first solid  $\alpha$  begins to form, which has a composition dictated by the tie line drawn at this temperature [i.e., 46 wt% Ni–54 wt% Cu, noted as ( $\alpha$ -46%Ni)]. With continued cooling, both compositions and relative amounts of each of the phases will change. The compositions of the liquid and  $\alpha$  phases will follow the liquidus and solidus lines, respectively. Furthermore, the fraction of the  $\alpha$  phase will increase with continued cooling.
- At 1250°C, point *c* in Figure 9.4, the compositions of the liquid and  $\alpha$  phases are 32 wt% Ni–68 wt% Cu [*L*(32 Ni)] and 43 wt% Ni–57 wt% Cu [ $\alpha$ (43% Ni)], respectively.
- The relative amounts (as fraction or as percentage) of the phases present at equilibrium may also be computed with the aid of phase diagrams. Then we have to apply the **lever rule**.

From figure,

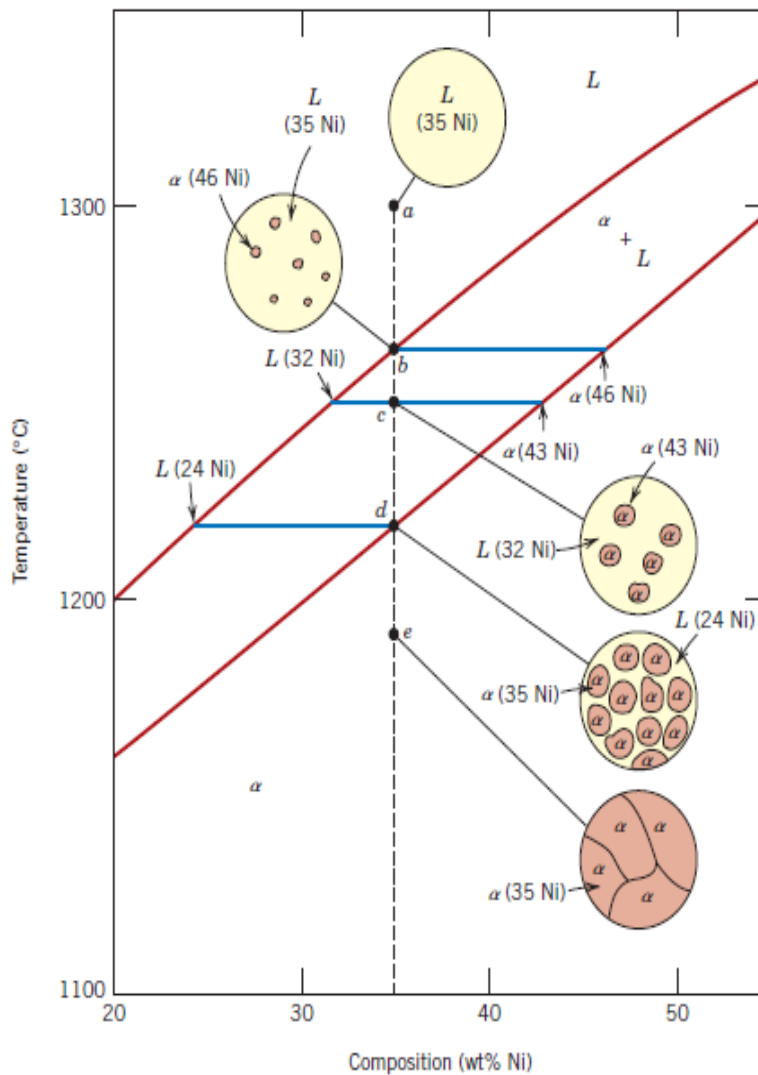
$$C_o = 35 \text{ wt\% Ni}$$

$$C_L = 32 \text{ wt\% Ni}$$

$$C_\alpha = 43 \text{ wt\% Ni}$$

$$W_L = \frac{C_\alpha - C_o}{C_\alpha - C_L} = \frac{43 - 35}{43 - 32} = 0.72 = 72\% \quad \text{and}$$

$$W_\alpha = \frac{C_o - C_L}{C_\alpha - C_L} = \frac{35 - 32}{43 - 32} = 0.28 = 28\%$$



Schematic representation of the development of microstructure during the equilibrium solidification of a 35 wt% Ni–65 wt% Cu alloy.

- At point d: The solidification process is virtually completed at about  $1220^{\circ}\text{C}$ . At the point *d*; the composition of the solid  $\alpha$  is approximately 35 wt% Ni–65 wt% Cu (the overall alloy composition), whereas that of the last remaining liquid is 24 wt% Ni–76 wt% Cu.
- At point e: Upon crossing the solidus line, the remaining liquid solidifies; the final product then is a polycrystalline  $\alpha$ -phase solid solution that has a uniform 35 wt% Ni–65 wt% Cu composition. Subsequent cooling will produce no microstructural or compositional alterations.

